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(12) **United States Design Patent**
Kouchi et al.

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(54) **WIRING BOARD**

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(**) Term: **14 Years**

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(30) **Foreign Application Priority Data**

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(52) **U.S. CL.**
USPC **D13/182**

(58) **Field of Classification Search**
USPC D13/162, 164, 177, 182, 184, 199;
D8/353; 29/829; 174/66, 377, 250,
174/253-257, 260; 361/820, 748, 749, 777,
361/679.01, 752, 760, 761, 762, 763, 764,
361/720, 722; 220/241
See application file for complete search history.

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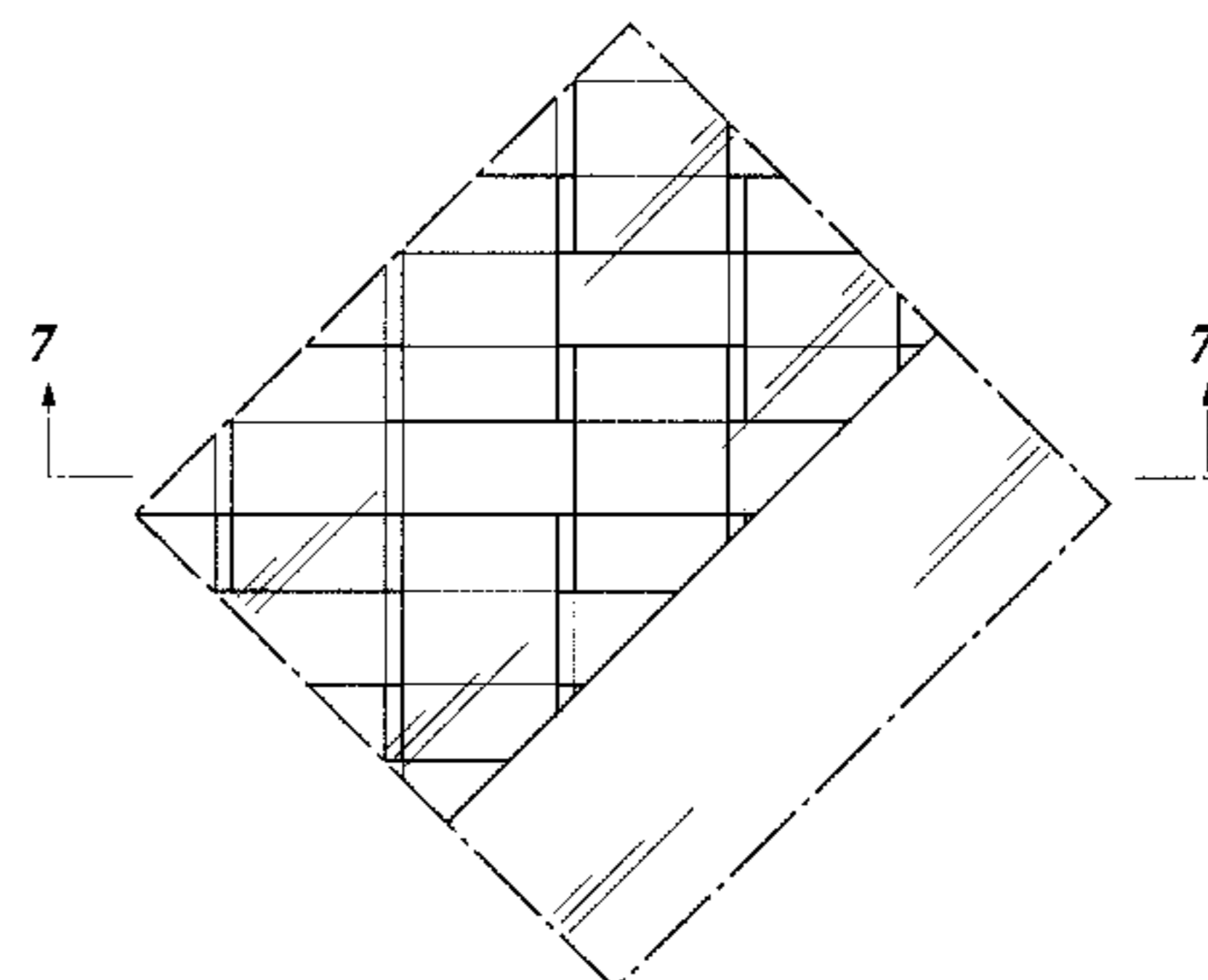
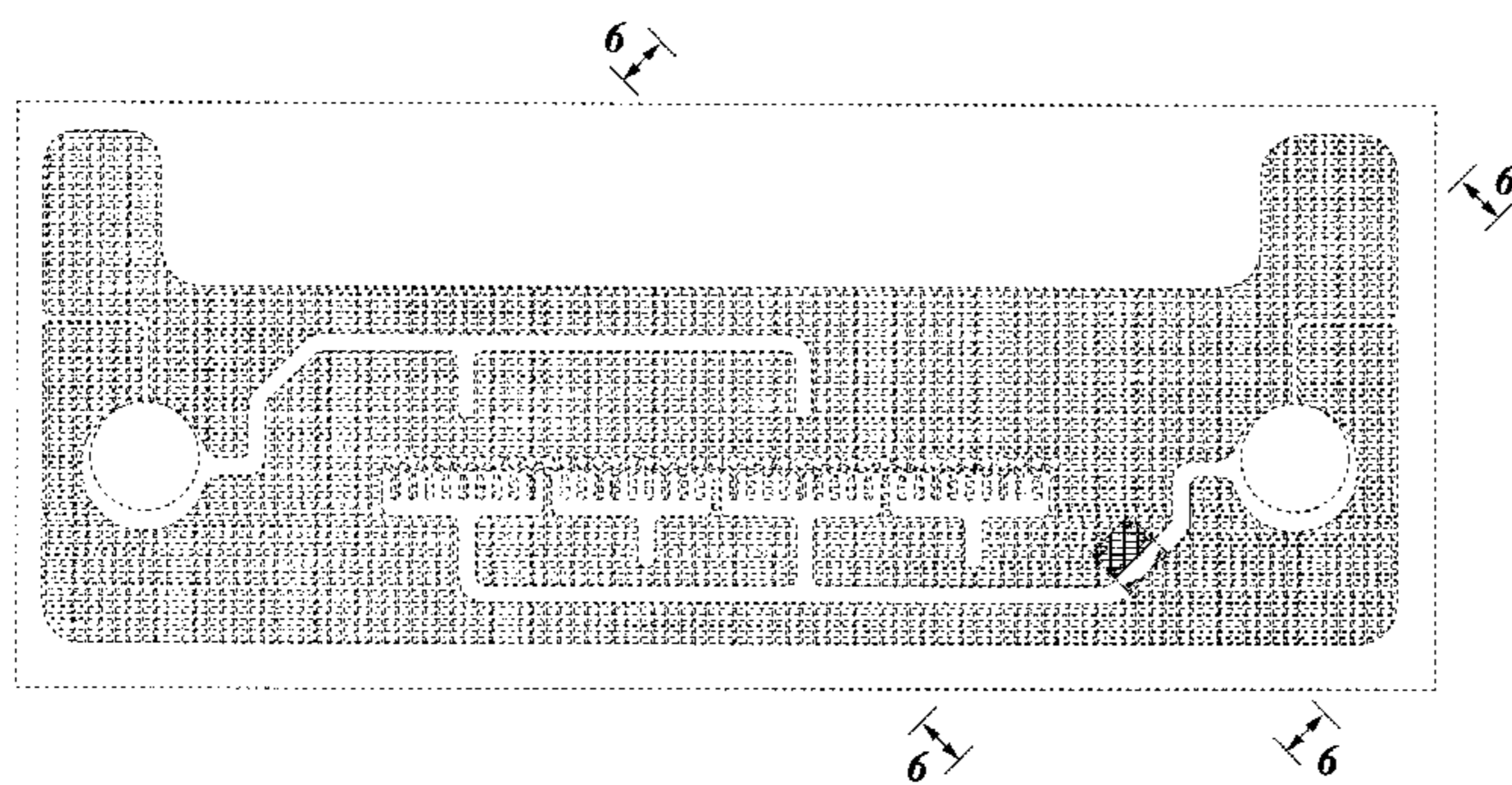
(57) **CLAIM**

The ornamental design for a wiring board, as shown and described.

DESCRIPTION

FIG. 1 is a front view of a wiring board showing our new design;
FIG. 2 is a top plan view thereof;
FIG. 3 is a bottom plan view thereof;
FIG. 4 is a right side view thereof;
FIG. 5 is a left side view thereof;
FIG. 6 is an enlarged front view of a portion taken along lines 6-6 in FIG. 1; and,
FIG. 7 is an enlarged cross sectional view taken along line 7-7 in FIG. 6.
The features shown in broken lines in the drawings depict environmental subject matter only and form no part of the claimed design. The dashed-dotted lines in FIGS. 1 and 6 denote the boundary of the claim and form no part of the claimed design. All sides not shown form no part of the claimed design.

1 Claim, 7 Drawing Sheets



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FIG. 1

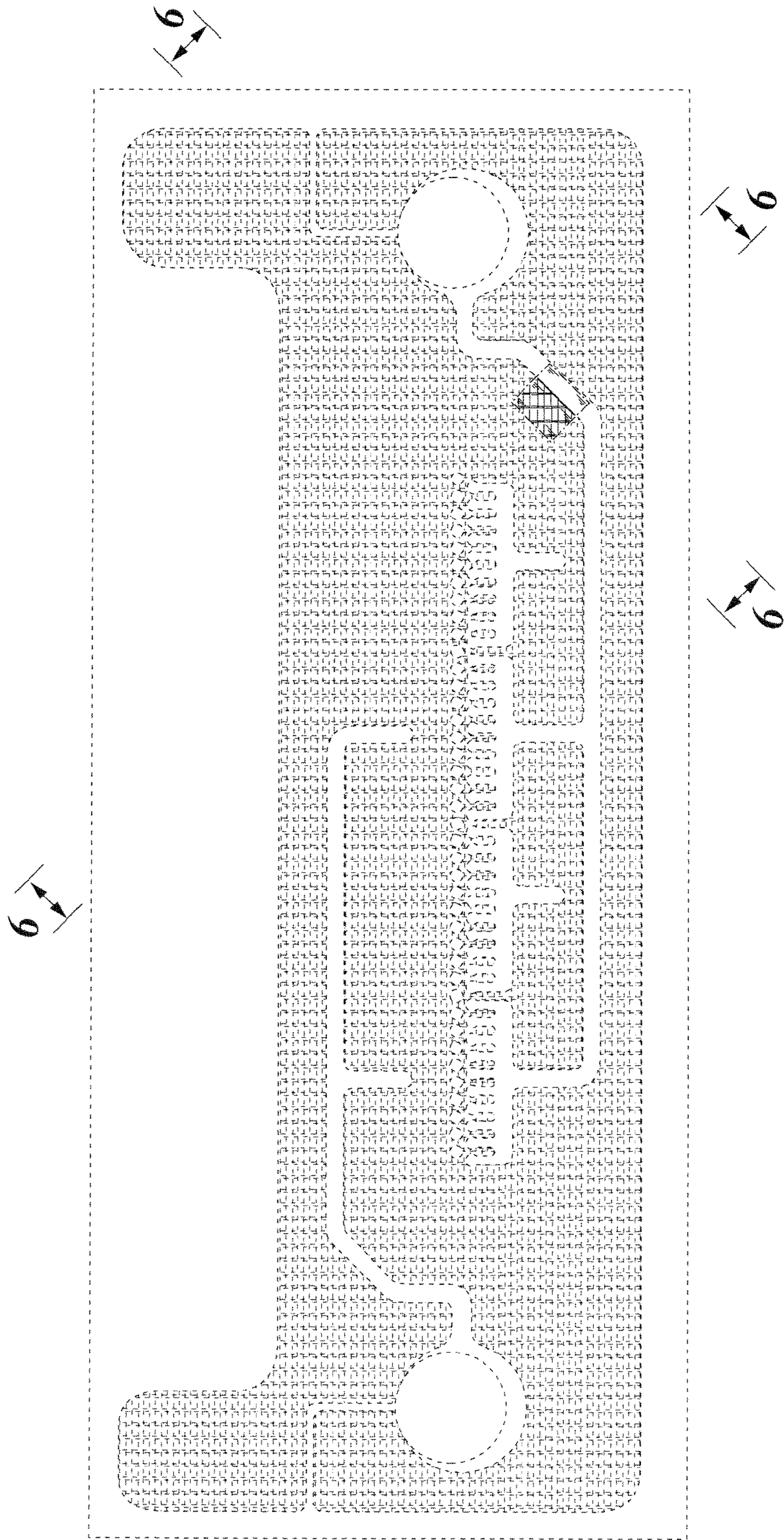


FIG. 2

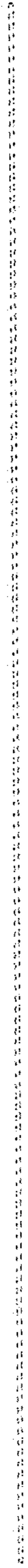


FIG. 3

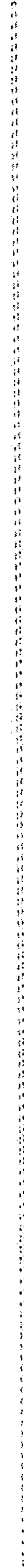


FIG. 4

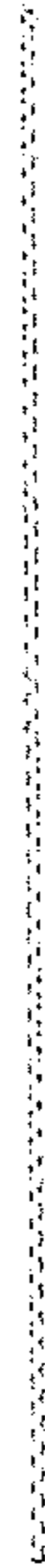


FIG. 5

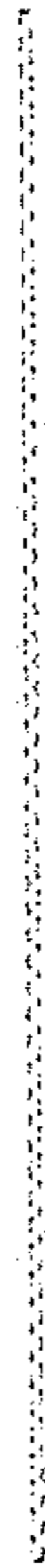


FIG. 6

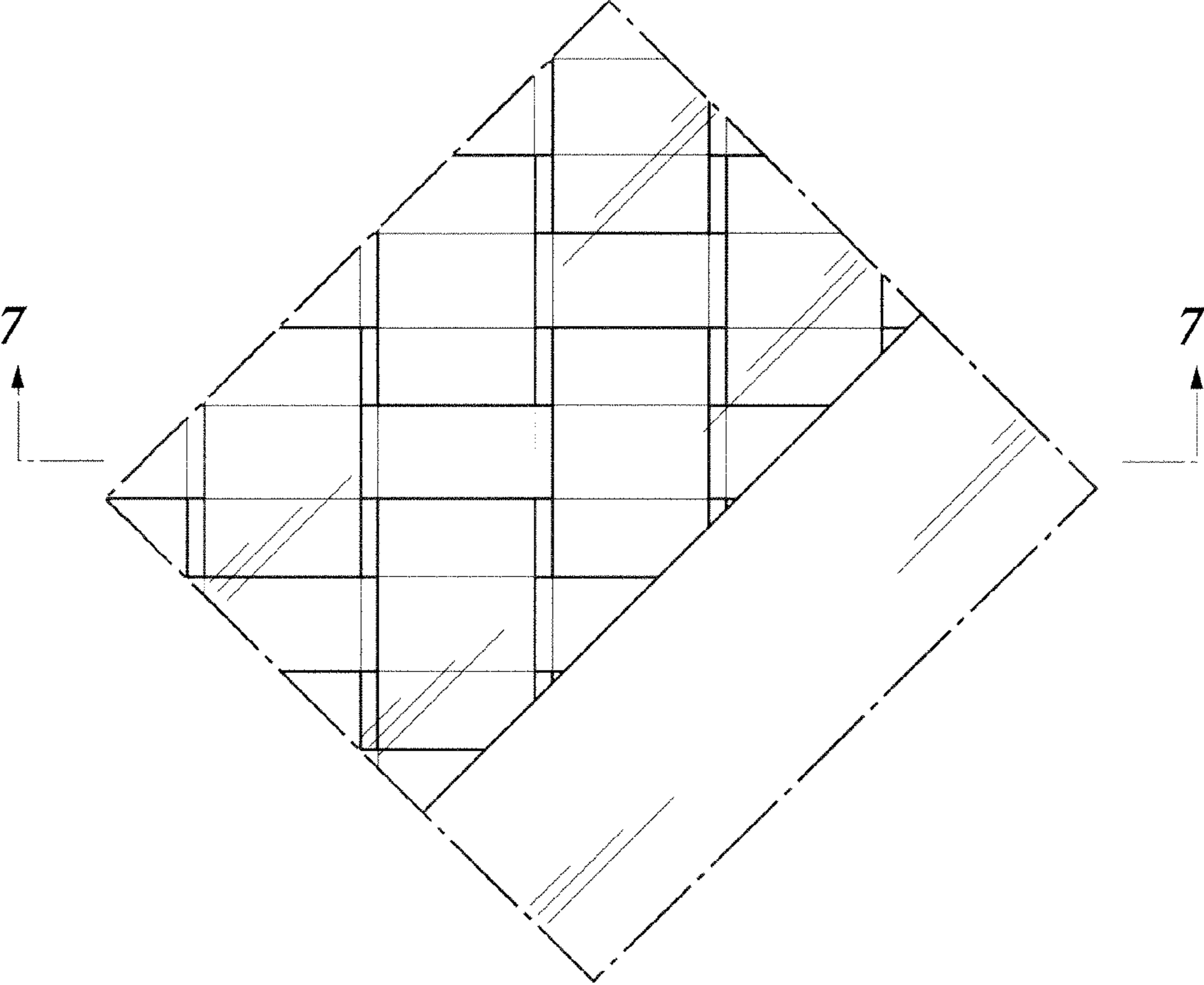


FIG. 7

